

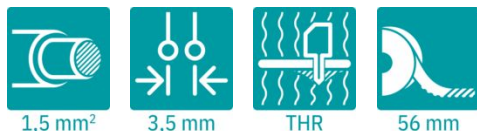
MCV 1,5/ 9-G-3,5 THTPIN26R56 - PCB header



1717440

<https://www.phoenixcontact.com/us/products/1717440>

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PCB headers, nominal cross section: 1.5 mm², color: black, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Sn, contact connection type: Pin, number of rows: 1, number of positions: 9, product range: MCV 1,5/-G-THT, pitch: 3.5 mm, mounting: THR soldering / wave soldering, pin layout: Linear pinning, solder pin [P]: 2.6 mm, plug-in system: COMBICON MC 1,5, Pin connector pattern alignment: Standard, locking: without, mounting method: without, type of packaging: 56 mm wide tape, For user information and design recommendations for through-hole reflow technology, go to: Downloads

Your advantages

- Designed for integration into the SMT soldering process
- Maximum flexibility when it comes to device design – one header for connectors with different connection technologies

Commercial data

Item number	1717440
Packing unit	200 pc
Minimum order quantity	200 pc
Note	Made to order (non-returnable)
Product key	AAB1GO
GTIN	4046356138543
Weight per piece (including packing)	5.342 g
Weight per piece (excluding packing)	4.172 g
Country of origin	DE

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Technical data

Product properties

Product type	PCB headers
Product family	MCV 1,5/...-G-THT
Type	Component suitable for through hole reflow
Number of positions	9
Pitch	3.5 mm
Number of rows	1
Mounting type	no
Pin layout	Linear pinning

Electrical properties

Properties

Nominal current I_N	8 A
Nominal voltage U_N	160 V
Contact resistance	1.7 mΩ
Rated voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	250 V
Rated surge voltage (II/2)	2.5 kV

Mounting

Mounting type	THR soldering / wave soldering
Pin layout	Linear pinning

Processing notes

Process	Reflow/wave soldering
Moisture Sensitive Level	MSL 3
Classification temperature T_c	260 °C
Solder cycles in the reflow	3

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 μm - 5 μm Sn)
Metal surface contact area (middle layer)	Nickel (1.3 μm - 3 μm Ni)
Metal surface soldering area (top layer)	Tin (3 μm - 5 μm Sn)

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Metal surface soldering area (middle layer)	Nickel (1.3 µm - 3 µm Ni)
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Material data - housing

Color (Housing)	black (9005)
Insulating material	PA
Insulating material group	IIIa
CTI according to IEC 60112	250
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

Dimensions

Pitch	3.5 mm
Width [w]	32.9 mm
Height [h]	11.8 mm
Length [l]	7.25 mm
Installed height	9.2 mm
Solder pin length [P]	2.6 mm

PCB design

Hole diameter	1.4 mm
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Mechanical tests

Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

Polarization and coding

Specification	IEC 60512-13-5:2006-02
Result	Test passed

Contact holder in insert

Specification	IEC 60512-15-1:2008-05
Contact holder in insert Requirements >20 N	Test passed

Insertion and withdrawal forces

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Specification	IEC 60512-13-2:2006-02
Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	7 N
Withdraw strength per pos. approx.	5 N

Electrical tests

Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	20

Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	IIIa
Comparative tracking index (IEC 60112)	CTI 250
Rated insulation voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	2.5 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.6 mm
Rated insulation voltage (II/2)	250 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	2.5 mm

Environmental and real-life conditions

Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	2.95 kV
Contact resistance R ₁	1.7 mΩ
Contact resistance R ₂	1.6 mΩ
Insertion/withdrawal cycles	25
Insulation resistance, neighboring positions	> 5 MΩ

Climatic test

Specification	ISO 6988:1985-02
Corrosive stress	0.2 dm ³ SO ₂ on 300 dm ³ /40 °C/1 cycle

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Thermal stress	100 °C/168 h
Power-frequency withstand voltage	1.39 kV

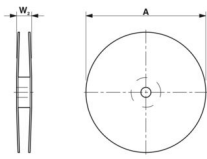
Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

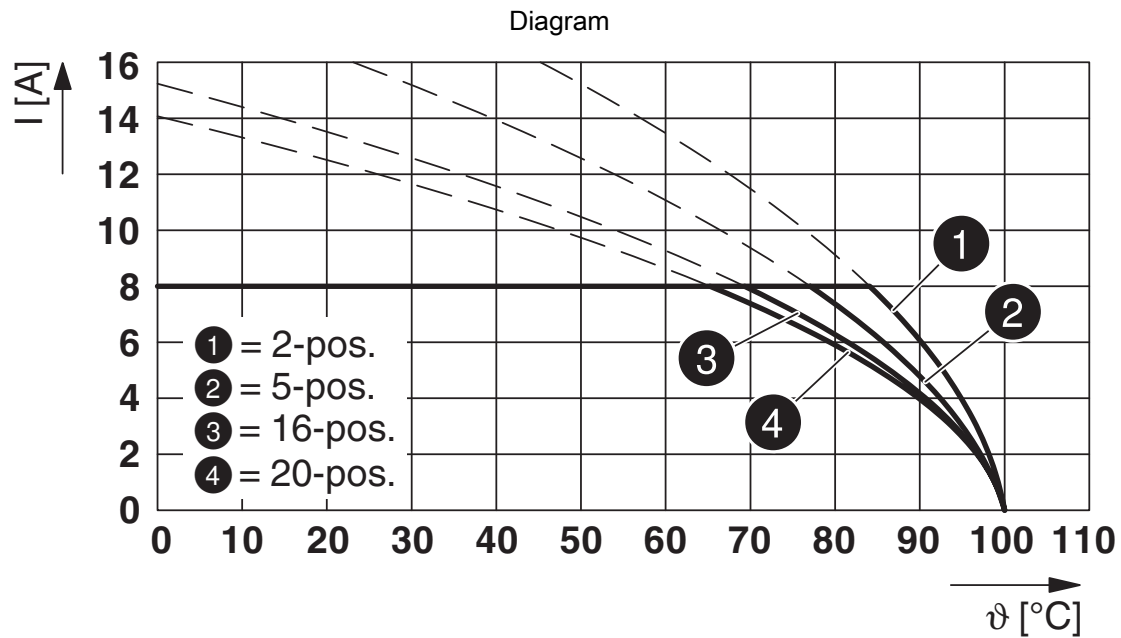
Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

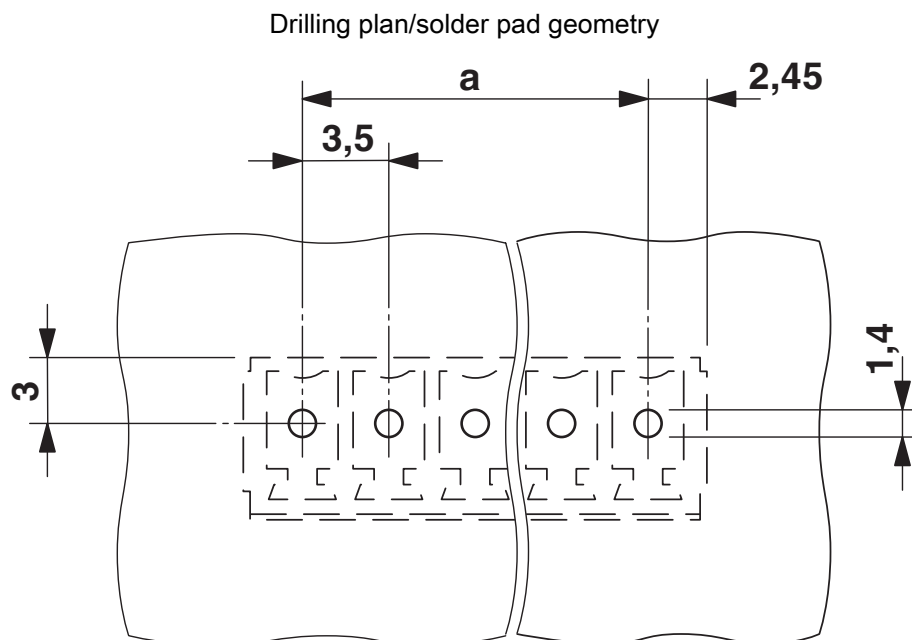
Packaging specifications

Dimensional drawing	
Type of packaging	56 mm wide tape
[W] tape width	56 mm
[W2] coil overall dimension	≤ 62.4 mm
[A] coil diameter	≤ 330 mm
Outer packaging type	Dry bag

Drawings



Type: FMC 1,5/...-ST-3,5 with MCV 1,5/...-G-3,5 THT



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Approvals

To download certificates, visit the product detail page: <https://www.phoenixcontact.com/us/products/1717440>

 cULus Recognized Approval ID: E60425-20110128				
	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
B	300 V	8 A	-	-
D	300 V	8 A	-	-

 VDE Zeichengenehmigung Approval ID: 40011723				
	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
keine	160 V	8 A	-	-

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Classifications

ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

ETIM

ETIM 10.0	EC002637
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Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions
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China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%
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